



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP4499	REV: A	SUN REV: Not In VersionControl
IGNORE ->			
PLOT NAME = Top Assembly Drawing	GENERATED : 4/11/2016	11:18:55 AM	TEXAS INSTRUMENTS

C42  
C45  
C46  
C41  
C43  
C44  
C34  
C35  
C37

C14  
C13  
C12  
R17  
R16  
C11  
R21  
C8  
R14  
C25  
C33  
C29  
R22  
R24

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP4499	REV: A	SUN REV: Not In VersionControl
IGNORE ->			
PLOT NAME = Bottom Assembly Drawing	GENERATED : 4/11/2016 11:18:55 AM		TEXAS INSTRUMENTS

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